MB005S~MB10S

Surface Mount Bridge Rectifier

Reverse Voltage - 50 to 1000 V Forward Current - 0.8 A

Features

- Glass Passivated Chip Junction
- High Surge Current Capability

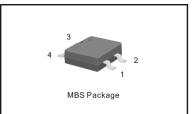
Mechanical Data

· Case: MBS, molded plastic.

• Terminals: Solderable per MIL-STD-750, Method 2026

PINNING

PIN	DESCRIPTION					
1	Input Pin (~)					
2	Input Pin (~)					
3	Output Anode (+)					
4	Output Cathode (-)					



Absolute Maximum Ratings and Characteristics

Ratings at T_a = 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or

inductive load. For capacitive load, derate current by 20%.

Parameter			MB1S	MB2S	MB4S	MB6S	MB8S	MB10S	Units
Parameter	Marking	MB005S	MB1S	MB2S	MB4S	MB6S	MB8S	MB10S	-
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	٧
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	٧
Maximum Average Forward Rectified Current	I _{F(AV)}	0.8						Α	
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	35						А	
Maximum Instantaneous Forward Voltage at 0.4 A	V _F	1						V	
	I _R	5 100						μΑ	
Typical Junction Capacitance 1)	CJ	13						pF	
Typical Thermal Resistance ²⁾	R _{0JA} R _{0JC}	80 28						°C/W	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 150						°C	

¹⁾ Measured at 1MHz and applied reverse voltage of 4 V D.C.



 $^{^{2)}}$ Mounted on glass epoxy PC board with 1.3 × 1.3 mm copper pad.

Electrical Characteristics Curves

Fig.1 Average Rectified Output Current **Derating Curve** 1.2 Average Rectified Output Current (A) 1.0 0.8 0.6 0.4 0.2 Resistive or Inductive Load 0.0 25 75 150 50 100 125 175 Case Temperature (°C)

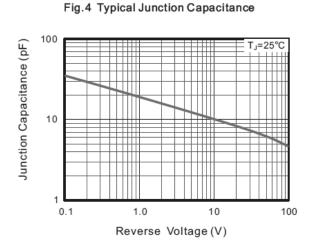
Instaneous Reverse Current (µA) 100 T_J=125°C 10 1.0 T_J=25°C 0.1 00 20 40 60 80 100 120 140 percent of Rated Peak Reverse Voltage (%)

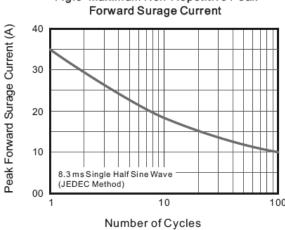
Fig.2 Typical Reverse Characteristics

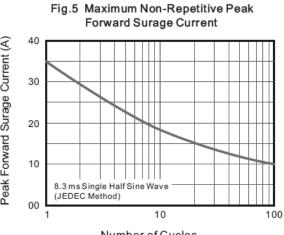
Characteristics Instaneous Forward Current (A) T_J=25°C 1.0 0.1 pulse with 300 µs 1% duty cycle 0.01 0.0 0.5 1.5 2.0 1.0

Instaneous Forward Voltage (V)

Fig.3 Typical Instaneous Forward





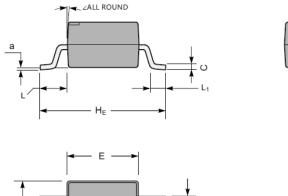


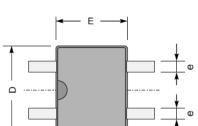


PACKAGE OUTLINE

Plastic surface mounted package; 4 leads

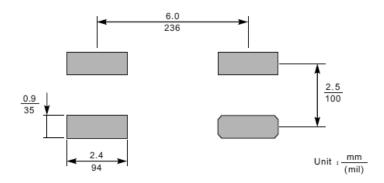
MBS





UNIT	Α	С	D	E	H _E	d	е	L	L ₁	а	_
mm	2.6 2.2	0.22 0.15	5.0 4.5	4.1 3.6	7.0 0.5	2.7 2.3	0.7 0.5	1.7 1.3	1.1 0.5	0.2	7°

Recommended Soldering Footprint



Marking information

" ***** " = Part No.

" YYWW " = Date Code Marking

" Y " = Year (ex: 19 = 2019)

"W" = Week (ex: 09 = the 9th week of the year)

Font type: Arial

